Final Product Change Notification | 201607005F01

Issue Date: 31-Aug-2016
Effective Date: 28-Nov-2016

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QUALITY

Change Category

[ ] Wafer Fab Process	[ ] Assembly Process	[ ] Product Marking	[ ] Test Location	[ ] Design
[ ] Wafer Fab Materials	[ ] Assembly Materials	[ ] Mechanical Specification	[ ]Test Process	[ ] Errata
[ ] Wafer Fab Location	[X] Assembly Location	[ ] Packing/Shipping/Labeling	[ ] Test Equipment	[ ] Electrical spec./Test coverage

MKL27/17 64LQFP Assembly Site Expansion to Nantong Fujitsu Microelectronics Co. Ltd

Details of this Change

NXP Semiconductor is announcing the assembly site expansion for the MKL27/17 64LQFP from the current NXP assembly, Tian Jin, China (ATTJ) assembly Facility to the NANTONG FUJITSU MICROELECTRONICS CO. LTD, Nantong, China (NFME) Facility.
Why do we Implement this Change
Qualification of the NANTONG FUJITSU MICROELECTRONICS CO. LTD, Nantong, China (NFME), assembly Facility to ensure manufacturing flexibility and customer supply assurance.
Identification of Affected Products
Top side marking
Refer to Remarks section for details

Product Availability

Sample Information
Samples are available from 19-Aug-2016
Production
Planned first shipment 18-Nov-2016

Impact

no impact to the product's functionality anticipated.
Data Sheet Revision
No impact to existing datasheet

Disposition of Old Products

NXP will reserve the right to ship from any location based on market demand situation.

Timing and Logistics

Your acknowledgement of this change, conform JEDEC JESD46 D, is expected till 30-Sep-2016.

Remarks

There is no change to orderable part number

The assembly site, among other information, is reflected in the package trace code.

The format for the NXP standard trace code: AWLYYWW is the following:

A=Assembly Site, WL=Wafer Lot, YY=Year, WW=Work Week.

The marking for NXP-ATTJ is A=CT.

The marking for NFME is A=XN.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

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Position   Product Engineer
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At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

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Changed Orderable Part#	Changed Part 12NC	Changed Part Number	Changed Part Description	Package Outline	Package Name	Status	Product Line
MKL27Z32VLH4	MKL27Z32VLH4	MKL27Z32VLH4	32-BIT, 32K FLASH	LQFP 64 10*10*1.4P0.5	LQFP 64 10*10*1.4P0.5	RFS	BL Microcontrollers
MKL17Z32VLH4	MKL17Z32VLH4	MKL17Z32VLH4	32-BIT, 32K FLASH	LQFP 64 10*10*1.4P0.5	LQFP 64 10*10*1.4P0.5	RFS	BL Microcontrollers
MKL17Z64VLH4	MKL17Z64VLH4	MKL17Z64VLH4	32-BIT, 64K FLASH	LQFP 64 10*10*1.4P0.5	LQFP 64 10*10*1.4P0.5	RFS	BL Microcontrollers
MKL27Z64VLH4	MKL27Z64VLH4	MKL27Z64VLH4	32-BIT, 64K FLASH	LQFP 64 10*10*1.4P0.5	LQFP 64 10*10*1.4P0.5	RFS	BL Microcontrollers